TOSHIBA PHOTOCOUPLER PHOTO RELAY

TLP179D

Measurement Instruments Logic IC Testers / Memory Testers Board Testers / Scanners

The TOSHIBA TLP179D Mini-flat photorelay is a small-outline photorelay, suitable for surface-mount assembly. The TLP179D consists of an infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Its characteristics include low OFF-state current and low output pin capacitance, enabling it to be used in high-frequency measurement instruments.

Features

4 pin SOP (2.54SOP4) : 2.1 mm high, 2.54 mm pitch

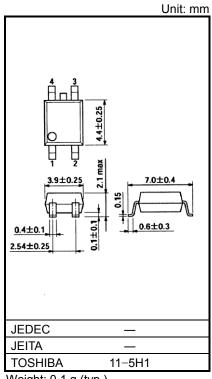
1-Form-A

• Peak OFF-State Voltage : 200 V (min) • Trigger LED Current : 3 mA (max) • ON-State Current : 50 mA (max) • ON-State Resistance : $50 \Omega (max)$ • Output Capacitance : 20 pF (max) : 1500 Vrms (min) • Isolation Voltage

: UL 1577, File No.E67349 • UL-recognized

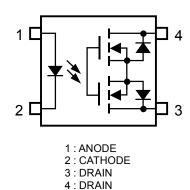
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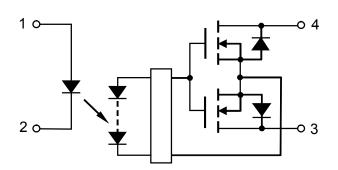


Weight: 0.1 g (typ.)

Pin Configuration (top view)



Schematic



Start of commercial production 2008-11

Absolute Maximum Ratings (Ta = 25°C)

	Characteristics	Symbol	Rating	Unit
	Forward Current	lF	50	mA
	Forward Current Derating (Ta ≥ 25°C)	ΔIF/°C	-0.5	mA/°C
Ω	Reverse Voltage	VR	5	V
쁘	Diode power dissipation	PD	50	mW
	Diode power dissipation derating (Ta >25°C)	∆P _D /°C	-0.5	mW/°C
	Junction Temperature	Tj	125	°C
	OFF-State Output Terminal Voltage	Voff	200	V
DETECTOR	ON-State Current	Ion	50	mA
	ON-State Current Derating (Ta ≥ 25°C)	Δlon/°C	-0.5	mA/°C
ETE	Output power dissipation	Po	125	mW
	Output power dissipation derating (Ta ≥ 25°C)	ΔPo/°C	-1.25	mW / °C
	Junction Temperature	Tj	125	°C
Stora	ge Temperature Range	T _{stg}	−55 to 125	°C
Opera	ating Temperature Range	T _{opr}	−40 to 85	°C
Lead	Soldering Temperature (10 s)	T _{sol}	260	°C
Isolat	ion Voltage (AC, 60 s, R.H.≤ 60 %) (Note1)	BVs	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note1: Device considered a two-terminal device : LED side pins shorted together, and DETECTOR side pins shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply Voltage	V _{DD}	_	_	160	٧
Forward Current	lF	5	7.5	15	mA
ON-State Current	Ion	_	_	50	mA
Operating Temperature	Topr	-20	_	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward Voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
ED	Reverse Current	I _R	V _R = 5 V	_	_	10	μΑ
	Capacitance between terminals	CT	V _F = 0 V, f = 1 MHz	_	30	_	pF
CTOR	OFF-State Current	loff	V _{OFF} = 160 V	ı	ı	1	nA
DETE	Capacitance between terminals	COFF	V = 0 V, f = 1 MHz	_	15	20	pF



Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED Current	I _{FT}	I _{ON} = 50 mA	_	1	3	mA
Return LED Current	IFC	IOFF = 100 μA	0.1	_	_	mA
ON-State Resistance	Ron	ION = 50 mA, I _F = 5 mA	_	40	50	Ω

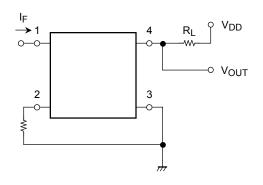
Isolation Characteristics (Ta = 25°C)

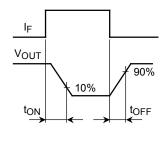
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance Input to Output	Cs	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation Resistance	Rs	V _S = 500 V, R.H. ≦ 60 %	5 × 10 ¹⁰	10 ¹⁴	_	Ω
Isolation Voltage	BVS	AC, 60 s	1500	_	-	Vrms

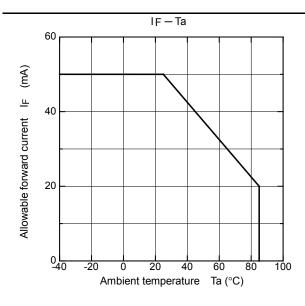
Switching Characteristics (Ta = 25°C)

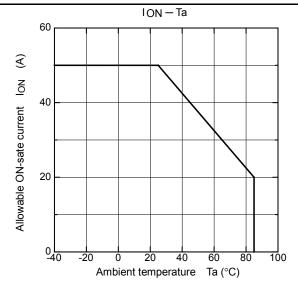
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on Time	ton	$R_L = 200 \Omega$ (No	e2) –	0.03	0.5	ma
Turn-off Time	toff	$V_{DD} = 10 \text{ V}, I_F = 5 \text{ mA}$	_	0.07	0.2	ms

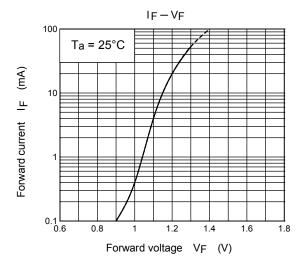
Note2: Switching Time Test Circuit

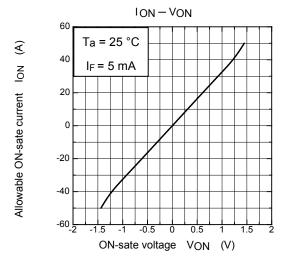


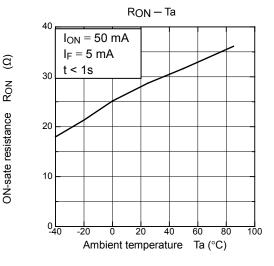


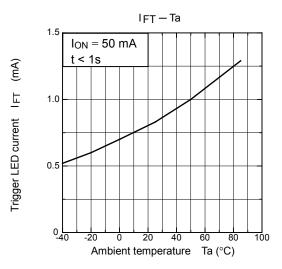




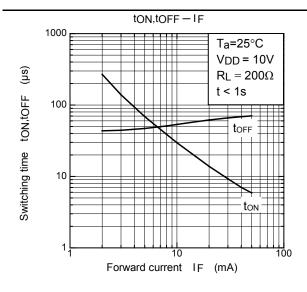


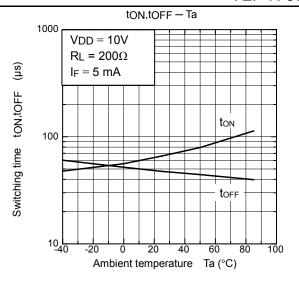


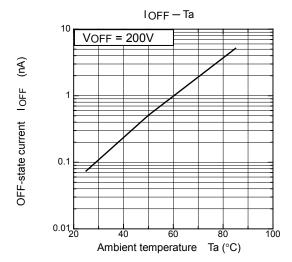




NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.







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